

TPS25942xEVM-635: Evaluation Module for TPS25942x

This user's guide describes the evaluation module (EVM) for the Texas instruments TPS25942x devices. The TPS25942x devices are eFuse with True Reverse Blocking for a Power Mux that operates from 2.7V to 18V, and the devices have integrated back-to-back FETs with programmable under-voltage, over-voltage, reverse-voltage, over-current and in-rush current protection features.

Contents

| 1 | Introduction |
|---|---|
| | 1.1 EVM Features |
| | 1.2 EVM Applications |
| 2 | Description |
| 3 | Schematic |
| 4 | General configurations |
| | 4.1 Physical Access |
| | 4.2 Test Equipment |
| | 4.3 Test Setup |
| | 4.4 Test Procedures |
| | 4.5 Preliminary Tests |
| | 4.6 Auto Power Mux (Active ORing) |
| | 4.8 Priority Power Mux with Almost Equal Rails (VIN1 ~ VIN2) |
| 5 | EVM Assembly Drawings and Layout Guidelines |
| 5 | 5.1 PCB Drawings |
| 6 | Bill of Materials (BOM) |
| | |
| | List of Figures |
| 1 | TPS25942xEVM Schematic |
| 2 | EVM Test Setup6 |
| 3 | Vout Ramp up Time for CH1 |
| 4 | Vout Ramp up Time for CH2 |
| 5 | J4 = LO Current Limit Test Auto Retry (CH1) |
| 6 | J9 = NO Jumper Current Limit Test with Latch (CH2) |
| 7 | Top Side Placement |
| 8 | Top Side Routing Layer |
| 9 | Bottom Side Routing Layer |
| Ü | Solid Rouning Edyor |
| | List of Tables |
| 1 | TPS25942x EVM Options and Default Settings |
| 2 | Input and Output Connector Functionality |
| 3 | Test Points Description |
| 4 | Jumper and LEDs Descriptions |
| 5 | EVM Configuration Settings |
| 6 | Operational Range Settings for VIN1, VIN2 = 12V, 5V, and 3.3V |
| 7 | PWR635 DMM Readings at Different Test Points |
| • | · · |
| 8 | PWR635 Oscilloscope Settings for Ramp Up Voltage Test |



Introduction www.ti.com

| 9 | PWR635 Oscilloscope Settings for Current Limit Test | ç |
|----|---|----|
| 10 | PWR635 Jumper Settings for Current Limits | ç |
| 11 | TPS25942xEVM-635 Bill of Materials | 14 |

1 Introduction

The TPS25942x-EVM allows reference circuit evaluation of TI's TPS25942x devices. The TPS25942x devices are available with both latched and auto-retry operation.

1.1 EVM Features

- General TPS25942xEVM features include:
 - 2.7-V to 18.0-V (typ) operation
 - CH1 Rising Input voltage turn-on threshold 10.5 V (TYP)
 - CH1 Falling Input voltage turn-off threshold 9.7 V (TYP)
 - CH2 Rising Input voltage turn-on threshold 2.3 V (TYP)
 - CH2 Falling Input voltage turn-off threshold 2.1 V (TYP)
 - 0.6A to 5.0 A programmable current limit
 - Programmable under voltage lockout/overvoltage
 - Programmable VOUT slew rate
 - Latched-off TPS25942LRUV (CH2)
 - Auto-retry TPS25942ARUV (CH1)
- · Push button RESET signal
- On-board transorb is for overvoltage input protection
- Common diode at output prevents negative spike when load is removed

1.2 EVM Applications

- · Solid state drives and hard disk drives
- · PCIe, RAID and NIC cards
- USB power switch
- Industrial
 - PLCs
 - Solid state relays and FAN control
- · Power path management
 - Active ORing
 - Priority power multiplexing

2 Description

The TPS25942xEVM-635 enables full evaluation of the TPS25942x devices. The EVM supports two versions (Auto- Retry and Latched) of the devices on two channels (CH1 and CH2 respectively). Input power is applied at J3 (CH1), J8 (CH2) while J2 (CH1)/J7 (CH2) provide the output connection to the load; refer to the schematic in Figure 1 and test setup in Figure 2.

D5/C1 (CH1), D9/C7 (CH2) provide input protection for the TPS25942x (U1 and U2 respectively) while D4/C2/C3/C4 (CH1), D8/C8/C9/C10 (CH2) provide output protection.

S1 allows U1 and S2 allows U2 to be RESET or disabled. A power good (PG) indicator is provided by D6 for CH2 and circuit faults can be observed with D2, D6. Scaled channel current can be monitored at TP11 and TP22 with a scale factor of 0.842V/A.



www.ti.com Schematic

Table 1. TPS25942x EVM Options and Default Settings

| | EVM VG B | | UVLO | | | Current Limit | | | Fault Response | |
|------------------|-----------------------------|-----------|-------|--------------------|-------|---------------|--------------|---------------|----------------|---------|
| Part Number | Function | Vin Range | CH1 | CH2 | OVP | LO setting | No Jumper | HI Setting | CH1 | CH2 |
| TPS25942xEVM-635 | Current Limiter with ENBLKb | 2.7V-18V | 10.5V | Internal (2.3V) | 16.5V | 3.6A | 2.1A | 5.3A | Auto- retry | Latched |

3 Schematic

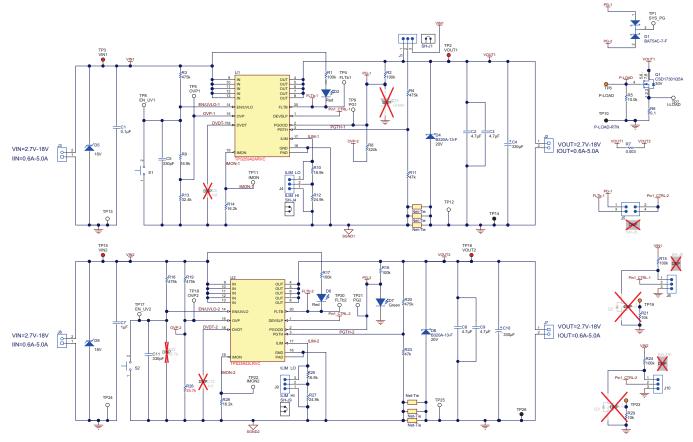


Figure 1. TPS25942xEVM Schematic



General configurations www.ti.com

4 General configurations

4.1 Physical Access

Table 2 lists the TPS25942xEVM-635 input and output connector functionality, Table 3 describes the test point availability, and Table 4 describes the jumper functionality

Table 2. Input and Output Connector Functionality

| Connector | | Label | Description |
|-----------|-----|------------------|-----------------------------------|
| J3 | CH1 | VIN1(+), GND(-) | CH1 Input power supply to the EVM |
| J2 | СП | VOUT1(+), GND(-) | CH1 Output power from the EVM |
| J8 | CH2 | VIN2(+), GND(-) | CH2 Input power supply to the EVM |
| J7 | CHZ | VOUT2(+), GND(-) | CH2 Output power from the EVM |

Table 3. Test Points Description

| Chann el | Test Points | Label | Description |
|-------------|----------------|--------|---|
| | TP3 | VIN1 | CH1 Input power supply to the EVM |
| | TP8 | EN_UV1 | CH1 Active high enable and under voltage input |
| | TP5 | OVP1 | CH1, Active high overvoltage input (>16.5V) |
| | TP11 | IMON1 | CH1 Current monitor. Load current = 1.187 × voltage on TP11 |
| CH1 | TP2 | VOUT1 | CH1 Output from the EVM |
| СПІ | TP9 | PG1 | CH1 Power good test point |
| | TP4 | FLTb1 | CH1, Fault test point |
| | TP12 | GND | GND |
| | TP13 | GND | GND |
| | TP14 | GND | GND |
| | TP15 | VIN2 | CH2 Input power supply to the EVM |
| | TP17 | EN_UV2 | CH2 Active high enable and under voltage input |
| | TP18 | OVP2 | CH2, Active high overvoltage input |
| | TP22 | IMON2 | CH2 Current monitor. Load current = 1.187 × voltage on TP22 |
| CH2 | TP16 | VOUT2 | CH2 Output from the EVM |
| CHZ | TP21 | PG2 | CH2 Power good test point |
| | TP20 | FLTb2 | CH2, Fault test point |
| | TP24 | GND | GND |
| | TP25 | GND | GND |
| | TP26 | GND | GND |

Table 4. Jumper and LEDs Descriptions

| Jumper | Label | Description |
|----------|---------|--|
| J1 | J1 | Priority Mux setting |
| J4 | LO – HI | CH2 current setting |
| J5 | J5 | PG1 and FLTb1 setting |
| J6 | J6 | DEVSLP1 setting |
| J9 | LO – HI | CH2 current setting |
| J10 | J10 | DEVSLP2 setting |
| D2 (Red) | D2 | CH1 circuit fault indicator. LED turns on when the internal MOSFET is disabled due to a fault condition such as over load, short circuit, under voltage etc. |
| D6 (Red) | D6 | CH2 circuit fault indicator. LED turns on when the internal MOSFET is disabled due to a fault condition such as over load, short circuit, under voltage etc. |



Table 4. Jumper and LEDs Descriptions (continued)

| Jumper | Label | Description |
|------------|-------|---|
| D7 (Green) | D9 | CH2 Power good indicator. LED turns on when the voltage at TP2(VOUT1) is more than 11 V |

Table 5 can be used to set the EVM in different configurations in order to achieve the desired functionality from the TPS25942xEVM-635.

Table 5. EVM Configuration Settings

| Jumper Location | | Auto Power Mux: 12V:12V | Priority Power Muxing | | | | |
|-----------------|------|--|---|--|--|--|--|
| | 1-2 | Install Jumper at this location for 5.3A current Limit for VIN1 | | | | | |
| J4 | 2-3 | Install Jumper at this location for 3.6A current Limit for VIN1 | | | | | |
| | OPEN | If No Jumper is installed def | ault current limit is 2.1A for VIN1 | | | | |
| | 1-2 | Install jumper at this location | n for 5.3A current Limit for VIN2 | | | | |
| J9 | 2-3 | Install jumper at this location | Install jumper at this location for 3.6A current Limit for VIN2 | | | | |
| | OPEN | If No Jumper is installed default current limit is 2.1A for VIN2 | | | | | |
| J5 | 1-2 | OPEN | OPEN | | | | |
| J5 | 3-4 | | | | | | |
| J1 | 1-2 | Install Jumper to get PG1 from VOUT1 | OPEN | | | | |
| JI | 2-3 | OPEN | Install Jumper to set VIN1 (Main) Priority over VIN2. | | | | |
| J6 | 1-2 | OPEN | OPEN | | | | |
| 36 | 2-3 | OPEN | OPEN | | | | |
| J10 | 1-2 | OPEN | OPEN | | | | |
| 310 | 2-3 | OPEN | OPEN | | | | |

4.2 Test Equipment

4.2.1 Power Supplies

One adjustable power supply: 0V to 20V output, 0A – 6A output current limit.

4.2.2 Meters

One DMM minimum needed and may require more if simultaneous measurements are needed.

4.2.3 Oscilloscope

A DPO2024 or Lecroy 424 oscilloscope or equivalent, three 10X voltage probes, and a DC current probe.

4.2.4 Loads

One resistive load or equivalent which takes up to a 6A DC load at 12V and capable of the output short.

4.3 Test Setup

Figure 2 shows a typical test setup for the TPS25942xEVM. Connect J3/J8 to the power supply and J2/J7 to the load.



General configurations www.ti.com

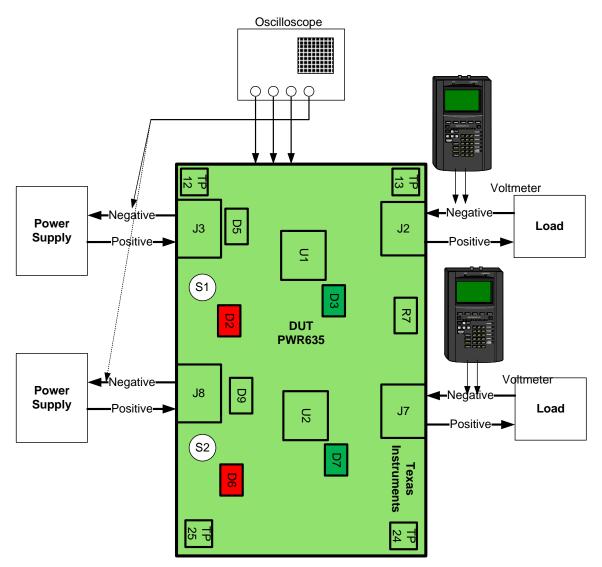


Figure 2. EVM Test Setup

4.4 Test Procedures

 The operational voltage range of the two rails VIN1 and VIN2 can be adjusted by changing a few resistor settings, as listed in Table 6.

Table 6. Operational Range Settings for VIN1, VIN2 = 12V, 5V, and 3.3V

| VIN Operational Range | Rail: VIN1 or VIN2 | R9 | R13 | R11 | R22 | R19 |
|-----------------------------|--------------------|-------|-------|------|--------|-------|
| 12V: 10.5V to 16V (default) | VIN1 | 16.9k | 32.4k | 47k | | |
| 5V: 4.6V to 5.7V | VIN1 | 23.2k | 105k | 137k | | |
| 3.3V: 3V to 3.8V | VIN1 | 48.7k | 187k | 237k | | |
| 2.3V to 15.5V (default) | VIN2 | | | | No PoP | 475k |
| 5V: 4.6V to 5.7V | VIN2 | | | | 130k | 169k |
| 3.3V: 3V to 3.8V | VIN2 | | | | 237k | 97.6k |



- Turn on the power supply and set the power supply voltage to 12V on CH1 and CH2.
- Turn off the power supply. Hook up CH1 and CH2 of the PWR635 assembly as shown in Figure 3.
- Ensure that the output load is disabled and the power supply is set properly for the DUT. Connect the negative probe of the DMM to TP12 or TP25 (GND) to the test points in Table 7.
- Turn on the power supply. Verify that the voltages shown in Table 7 are obtained. Only one power supply at a time for this verification.

Table 7. PWR635 DMM Readings at Different Test Points

| Voltage Test on (CH1) | Measured Voltage Reading | Voltage Tested on (CH2) | Measured Voltage Reading |
|-----------------------|-----------------------------|-------------------------|-----------------------------|
| VIN1 (TP3) | 12 ± 0.3 VDC | VIN2 (TP15) | 12 ± 0.3 VDC |
| EN_UV1 (TP8) | 1.13 ± 0.1 VDC | EN_UV2 (TP17) | 12 ± 1 VDC |
| OVP1 (TP5) | 0.742 ± 0.1 VDC | OVP2 (TP18) | Conditional ⁽¹⁾ |
| IMON1 (TP11) | 33.8 mV ± 5 mVDC | IMON2 (TP22) | 33.8 mV ± 5 mVDC |
| VOUT1 (TP2) | 12 ± 0.3 VDC | VOUT2 (TP16) | 12 ± 0.3 VDC |
| PG1 (TP9) | 9.30 ± 2.0 VDC | PG2 (TP21) | 2.4 ± 0.2 VDC |
| FLTb1 (TP4) | 10.51 ± 0.5 VDC | FLTb2 (TP20) | 10.5 ± 0.5VDC |

⁽¹⁾ OVP2 is > 1V if VIN1 is within the defined input voltage range otherwise < 0.97V, this sets the VIN1 priority over VIN2.</p>

4.5 Preliminary Tests

4.5.1 For CH1 (J3-J2)

- With the power supply set to 12V on CH1, verify that the red LED (D2) is off. Press the EVM RST switch (S1) and verify that the voltage at VOUT1 (TP2) starts falling slowly below 12V and that the FLTb1 red LED (D2) turns ON. Release S1.
- Reduce the input voltage on VIN1 and monitor VOUT1. Verify that VOUT1 (TP2) starts falling and is
 fully turned off when VIN1 (TP3) reaches 9.5V (±0.5V). Verify that the FLTb1 red LED (D2) turns ON.
- Increase the input voltage on VIN1 and monitor VOUT1. Verify that VOUT1(TP2) starts increasing and is fully turned off when VIN1(TP3) reaches 16.5V(±1V). Verify that the FLTb1 red LED (D2) turns ON.

4.5.2 For CH2 (J8-J7)

- With the power supply set to 12V on VIN1 and VIN2, verify that the green PG LED (D7) and the red LED (D6) are on (CH1 has priority over CH2).
- Set VIN1 = 0. Verify that the green PG LED (D7) is on.
- With the power supply set to 12V on VIN2, press the EVM RST switch (S2) and verify that the voltage at VOUT2 (TP16) starts falling slowly below 12V and that the green PG LED (D7) turns off and the RED FLTb2 LED (D6) turns on. Release S2.
- Reduce the input voltage on VIN2 and monitor VOUT2. Verify that VOUT2 (TP16) starts falling and is
 fully turned off when VIN2 (TP15) reaches 2.1V (+0.3V). Verify that the PG2 green LED (D7) turns off
 and the FLTb2 red LED (D6) turns ON.
- Increase the input voltage on VIN2 and monitor VOUT2. Verify that VOUT2 (TP16) starts increasing
 and is fully turned off when VIN2 (TP15) reaches 15.5V (±1V). Verify that the PG2 green LED (D7)
 turns off and the FLTb2 red LED (D6) turns ON.
- Turn off both power supplies.



General configurations www.ti.com

4.5.3 Ramp up Time Test (CH1 and CH2)

 Verify ramp up time (CH1 and CH2, with only 1 channel powered at a time). Set up the oscilloscope as listed in Table 8.

Table 8. PWR635 Oscilloscope Settings for Ramp Up Voltage Test

| Oscilloscope Setting | CH1 Probe Points | CH2 Probe Points |
|--------------------------------|------------------|------------------|
| Channel 1 = 5V/div | TP2 = VOUT1 | TP16 = VOUT2 |
| Channel 2 = 5V/div | TP3 = VIN1 | TP15 = VIN2 |
| Channel 3 = 2V/div | TP8 = EN/UVLO1 | TP17 = EN/UVLO2 |
| Trigger source = Channel 1 | | |
| Trigger level = 6.0 ± 0.5 V | | |
| Trigger polarity = Positive | | |
| Trigger mode = Single sequence | | |
| Time base = 1ms/div | | |

• Set the output load at 100Ω on CH1 and then enable the load. Turn on the power supply, press the EVM RST switch (S1) and release, and verify that VOUT1 (TP2) ramps up as shown in Figure 3.

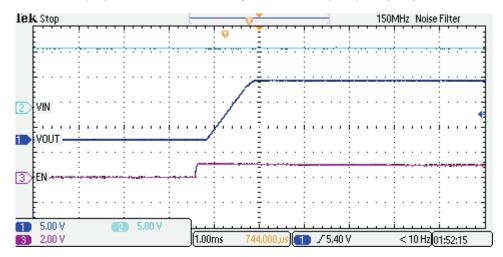


Figure 3. Vout Ramp up Time for CH1

• Set the output load at 100Ω on CH2 and then enable the load. Turn on the power supply, press the EVM RST switch (S2) and release, and verify that VOUT2 (TP16) ramps up as shown in Figure 4.

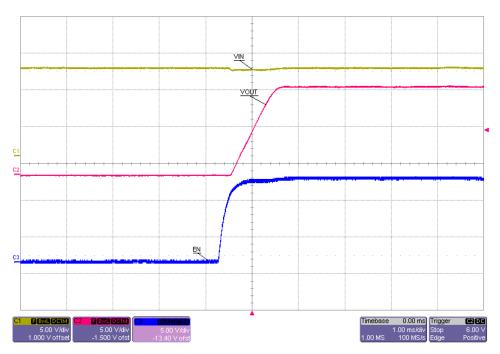


Figure 4. Vout Ramp up Time for CH2

4.5.4 Current Limit Tests

• Verify all three current limits (CH1 and CH2, with only 1 channel powered at a time) and verify the latch and auto-retry feature. Set up the oscilloscope as listed in Table 9.

Table 9. PWR635 Oscilloscope Settings for Current Limit Test

| Oscilloscope Setting | CH1 Probe Points | CH2 Probe Points |
|--------------------------------|--------------------------------|--------------------------------|
| Channel 1 = 5V/div | TP2 = VOUT1 | TP16 = VOUT2 |
| Channel 2 = 5V/div | TP3 = VIN1 | TP15 = VIN2 |
| Channel 4 = 2A/div | Input current into J3 +ve wire | Input current into J8 +ve wire |
| Trigger source = Channel 4 | | |
| Trigger level = 1.0 ± 0.2 A | | |
| Trigger polarity = +ve | | |
| Trigger mode = Single sequence | | |
| Time base | 40ms/div | 100ms/div |

- Note: If an electronic load is used, ensure that the output load is set to constant resistance mode and not constant current mode.
- Note: Measuring Current Limit values on the oscilloscope can easily cause 10% error from anticipated values listed in Table 10.
- Note: Since the pulse width of current can vary significantly with the VIN ramp rate, which varies from one power supply to another, do NOT worry about matching the pulse widths of Figure 5 and Figure 6.
- The jumper settings for the different current limits are listed in Table 10.

Table 10. PWR635 Jumper Settings for Current Limits

| Jumper | Load Current Limit | | | |
|----------|--------------------|--------------------|--|--|
| J4 (CH1) | J9 (CH2) | Load Current Linnt | | |
| HI | HI | 5.3A | | |
| LO | LO | 3.6A | | |



General configurations www.ti.com

Table 10. PWR635 Jumper Settings for Current Limits (continued)

| Jumper | Load Current Limit | | |
|-----------|--------------------|--------------------|--|
| J4 (CH1) | J9 (CH2) | Load Current Linit | |
| No Jumper | No Jumper | 2.1A | |

Set the output load at $1.0\pm0.1\Omega$ on CH1 and then enable the load. Turn on the power supply and verify that input current is limited as per the settings in Table 10 and the device is latched and FLTb1, RED LED (D3) turns on.

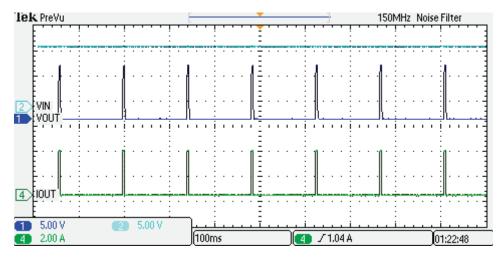


Figure 5. J4 = LO Current Limit Test Auto Retry (CH1)

Set the output load at $1.0\pm0.1\Omega$ on CH2 and then enable the load. Turn on the VIN2 power supply and verify that the input current is limited as per the settings in Table 10 and the device is in latched-off mode and FLTb1 RED LED (D2) turns ON as shown in Figure 6.

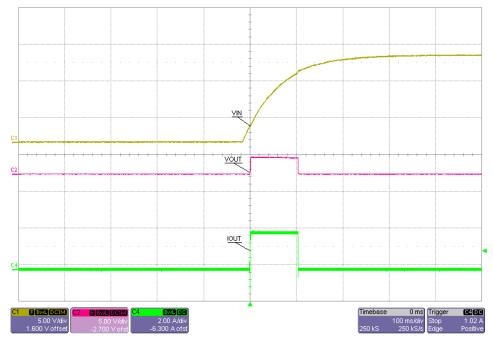


Figure 6. J9 = NO Jumper Current Limit Test with Latch (CH2)

Set the input power supply to zero volts and disconnect all equipment from the DUT.



4.6 Auto Power Mux (Active ORing)

The TPS25942xEVM-635 can be configured in the "Auto Power Mux" configuration by depopulating R8. In the Auto Power Mux configuration, within the programmed operation range of VIN1 and VIN2, the higher rail supplies the load, while the lower rail gets cut-off from the load. If the two rails are equal, the load is shared between the two rails. If any rail drops out of the programmed operation range, that rail is cut-off from the load. For a detailed explanation, consult the System Examples section of the TPS25942 data sheet.

4.7 Priority Power Mux

The TPS25942xEVM-635 is configured by default in the "Priority Power Mux" configuration, with priority of VIN1 (MAIN) over VIN2 (AUX). This means VIN1 will provide power to the load within the specified range of input voltage at VIN1, irrespective of VIN2 voltage level. When VIN1 falls out of the desired voltage range, U2 starts powering the load. This is called VIN1 priority over VIN2. For a detailed explanation, consult the System Examples section of the TPS25942 data sheet.

4.8 Priority Power Mux with Almost Equal Rails (VIN1 ~ VIN2)

When the two rails being muxed are close to each other, VIN1 (MAIN) is within 1 diode drop of VIN2 (AUX), U2 can be operated in "Diode Mode" for a faster switch-over. The faster switch-over reduces the required hold-up capacitor on the output rail for a given droop specification. The TPS25942xEVM-635 allows this by populating the J5 shunt. For a detailed explanation, consult the System Examples section of the TPS25942 data sheet.



5 EVM Assembly Drawings and Layout Guidelines

5.1 PCB Drawings

Figure 7 through Figure 9, show component placement and layout of the EVM.

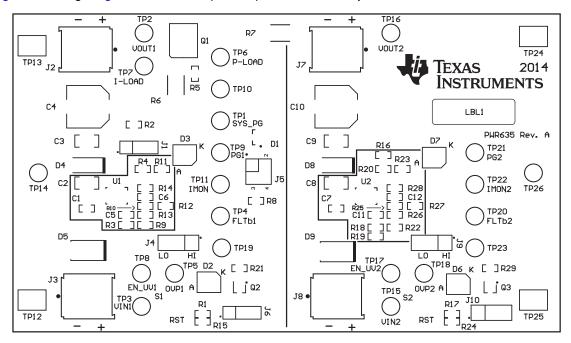


Figure 7. Top Side Placement

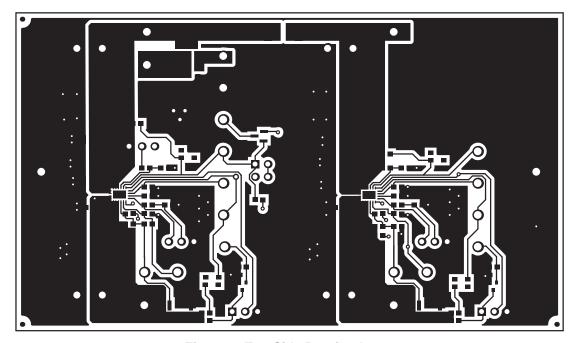


Figure 8. Top Side Routing Layer



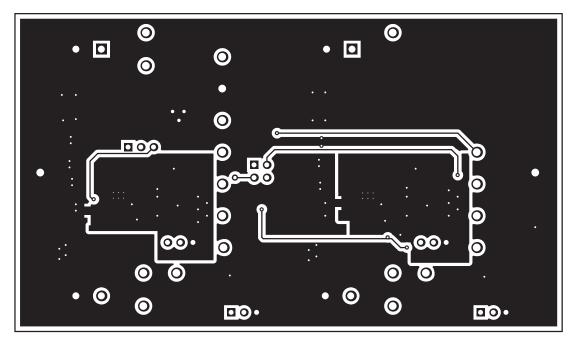


Figure 9. Bottom Side Routing Layer



Bill of Materials (BOM) www.ti.com

6 Bill of Materials (BOM)

Table 11. TPS25942xEVM-635 Bill of Materials

| Designator | OTV | Value | Description | Package Reference | Part No. | MFG. | Alternate | |
|--------------------------|-----|-------|---|----------------------------------|---------------------|-----------------------------|------------|----------|
| | QTY | | | | | | Part No. | MFG |
| PCB | 1 | | Printed Circuit Board | | PWR635 | Any | _ | _ |
| C1 | 1 | 0.1µF | CAP, CERM, 0.1µF, 25V, ±10%, X7R, 0603 | 0603 | 06033C104KAT2A | AVX | | |
| C2, C3, C8, C9 | 4 | 4.7µF | CAP, CERM, 4.7µF, 25V, ±10%, X7R, 1206 | 1206 | C3216X7R1E475K | TDK | | |
| C4, C10 | 2 | 330µF | CAP, AL, 330µF, 25V, ±20%, 0.16 ohm, SMD | HA0 | EMZA250ADA331MHA0G | Nippon Chemi-Con | | |
| C5, C11 | 2 | 330pF | CAP, CERM, 330pF, 100V, ±5%, X7R, 0603 | 0603 | 06031C331JAT2A | AVX | | |
| C7 | 1 | 1µF | CAP, CERM, 1µF, 25V, ±10%, X5R, 0603 | 0603 | C1608X5R1E105K080AC | TDK | | |
| D1 | 1 | 30V | Diode, Schottky, 30V, 0.2A, SOT-23 | SOT-23 | BAT54C-7-F | Diodes Inc. | | |
| D2, D6 | 2 | Red | LED, Red, SMD | Power TOPLED w/lens | LS E63F-DBFA-1-Z | OSRAM | _ | _ |
| D4, D8 | 2 | 20V | Diode, Schottky, 20V, 3A, SMA | SMA | B320A-13-F | Diodes Inc. | | |
| D5, D9 | 2 | 16V | Diode, TVS, Uni, 16V, 600W, SMB | SMB | SMBJ16A-13-F | Diodes Inc. | | |
| D7 | 1 | Green | LED, Green, SMD | Power TOPLED w/lens | LT E63C-CADB-35-L-Z | OSRAM | _ | _ |
| FID1, FID2, FID3 | 3 | | Fiducial mark. There is nothing to buy or mount. | Fiducial | N/A | N/A | | |
| H1, H2, H3, H4 | 4 | | Bumpon, Cylindrical, 0.312 x 0.200, Black | Black Bumpon | SJ61A1 | 3M | | |
| J1, J4, J6, J9, J10 | 5 | 1x3 | Header, TH, 100mil, 1x3, Gold plated, 230 mil above insulator | PBC03SAAN | PBC03SAAN | Sullins Connector Solutions | Equivalent | Any |
| J2, J3, J7, J8 | 4 | | Terminal Block, 2x1, 5.08mm, TH | 10.16 x 15.2 x 9 mm | 282841-2 | TE Connectivity | | |
| J5 | 1 | | Header, TH, 100mil, 2x2, Gold plated, 230 mil above insulator | TSW-102-07-G-D | TSW-102-07-G-D | Samtec, Inc. | Equivalent | Any |
| LBL1 | 1 | | Thermal Transfer Printable Labels, 0.650" W x 0.200"H - 10,000 per roll | PCB Label 0.650" H x 0.200" W | THT-14-423-10 | Brady | _ | _ |
| Q1 | 1 | 30V | MOSFET, N-CH, 30V, 100A, SON 5x6mm | SON 5x6mm | CSD17301Q5A | Texas Instruments | None | None |
| R1, R2, R16, R17 | 4 | 100k | RES, 100kΩ, 5%, 0.1W, 0603 | 0603 | CRCW0603100KJNEA | Vishay-Dale | | |
| R3, R4, R18, R19, R20 | 5 | 475k | RES, 475kΩ, 1%, 0.1W, 0603 | 0603 | CRCW0603475KFKEA | Vishay-Dale | Equivalent | Any |
| R5 | 1 | 10.0k | RES, 10.0kΩ, 1%, 0.1W, 0603 | 0603 | CRCW060310K0FKEA | Vishay-Dale | Equivalent | Any |
| R6 | 1 | 0.1 | RES, 0.1 Ω, 1%, 3W, 2512 | 2512 | CRA2512-FZ-R100ELF | Bourns | | |
| R7 | 1 | 0.003 | RES, 0.003 Ω, 1%, 1W, 2512 | 2512 | 73M1R003F | CTS Resistor | | |
| R8 | 1 | 324k | RES, 324kΩ, 1%, 0.1W, 0603 | 0603 | RC0603FR-07324KL | Yageo America | | |
| R9, R10, R25 | 3 | 16.9k | RES, 16.9kΩ, 1%, 0.1W, 0603 | 0603 | CRCW060316K9FKEA | Vishay-Dale | No Value | No Value |
| R11, R23 | 2 | 47k | RES, 47kΩ, 5%, 0.1W, 0603 | 0603 | CRCW060347K0JNEA | Vishay-Dale | | |
| R12, R27 | 2 | 24.9k | RES, 24.9kΩ, 1%, 0.1W, 0603 | 0603 | CRCW060324K9FKEA | Vishay-Dale | | |
| R13 | 1 | 32.4k | RES, 32.4k ohm, 1%, 0.1W, 0603 | 0603 | CRCW060332K4FKEA | Vishay-Dale | | |
| R14, R28 | 2 | 16.2k | RES, 16.2kΩ, 1%, 0.1W, 0603 | 0603 | CRCW060316K2FKEA | Vishay-Dale | | |
| R15, R24 | 2 | 100k | RES, 100kΩ, 1%, 0.1W, 0603 | 0603 | CRCW0603100KFKEA | Vishay-Dale | | |
| R21, R29 | 2 | 10k | RES, 10kΩ, 5%, 0.1W, 0603 | 0603 | CRCW060310K0JNEA | Vishay-Dale | | |



Bill of Materials (BOM) www.ti.com

Table 11. TPS25942xEVM-635 Bill of Materials (continued)

| Designator | QTY | Value | Description | Pankaga Pafaranas | Part No. | MFG. | Alternate | |
|--|-----|--------|---|----------------------------------|---------------------|-------------------------|--------------|--------|
| | QIY | Value | | Package Reference | | | Part No. | MFG |
| R26 | 1 | 35.7k | RES, 35.7k ohm, 1%, 0.1W, 0603 | 0603 | RC0603FR-0735K7L | Yageo America | | |
| S1, S2 | 2 | | Switch, Push Button, SMD | 2.9x2x3.9mm SMD | SKRKAEE010 | Alps | Equivalent | Any |
| SH-J1, SH-J4, SH-J9, | 3 | 1x2 | Shunt, 100mil, Gold plated, Black | Shunt | 969102-0000-DA | 3M | SNT-100-BK-G | Samtec |
| TP1, TP4, TP5, TP8, TP9, TP11, TP17, TP18, TP20, TP21, TP22 | 11 | White | Test Point, TH, Multipurpose, White | Keystone5012 | 5012 | Keystone | Equivalent | Any |
| TP2, TP3, TP15, TP16 | 4 | Red | Test Point, TH, Multipurpose, Red | Keystone5010 | 5010 | Keystone | Equivalent | Any |
| TP6, TP19, TP23 | 3 | Orange | Test Point, Multipurpose, Orange, TH | Orange Multipurpose Testpoint | 5013 | Keystone | | |
| TP7 | 1 | White | Test Point, Multipurpose, White, TH | White Multipurpose Testpoint | 5012 | Keystone | | |
| TP10, TP14, TP26 | 3 | Black | Test Point, TH, Multipurpose, Black | Keystone5011 | 5011 | Keystone | Equivalent | Any |
| TP12, TP13, TP24, TP25 | 4 | SMT | Test Point, SMT, Compact | Testpoint Keystone Compact | 5016 | Keystone | Equivalent | Any |
| U1 | 1 | | 2.7V-18V eFuse with True Reverse Blocking for Power Mux, RVC0020A | RVC0020A | TPS25942ARVC | Texas Instruments | | None |
| U2 | 1 | | 2.7V-18V eFuse with True Reverse Blocking for Power Mux, RVC0020A | RVC0020A | TPS25942LRVC | Texas Instruments | | None |
| C6, C12 | 0 | 1000pF | CAP, CERM, 1000pF, 100V, ±20%, X7R, 0603 | 0603 | 06031C102MAT2A | AVX | _ | _ |
| D3 | 0 | Green | LED, Green, SMD | Power TOPLED w/lens | LT E63C-CADB-35-L-Z | OSRAM | _ | _ |
| Q2, Q3 | 0 | 60V | MOSFET, N-CH, 60V, 0.31A, SOT-323 | SOT-323 | 2N7002KW | Fairchild Semiconductor | | None |
| R22 | 0 | 48.7k | RES, 48.7kΩ, 1%, 0.1W, 0603 | 0603 | CRCW060348K7FKEA | Vishay-Dale | | |
| SH-J5, SH-J6, SH- J10 | 0 | 1x2 | Shunt, 100mil, Gold plated, Black | Shunt | 969102-0000-DA | 3M | SNT-100-BK-G | Samtec |

Note: Unless otherwise noted in the Alternate PartNumber and/or Alternate Manufacturer columns, all parts may be substituted with equivalents.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products Applications

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive amplifier.ti.com Communications and Telecom www.ti.com/communications Amplifiers **Data Converters** dataconverter.ti.com Computers and Peripherals www.ti.com/computers **DLP® Products** www.dlp.com Consumer Electronics www.ti.com/consumer-apps DSP dsp.ti.com **Energy and Lighting** www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical Logic Security www.ti.com/security logic.ti.com

Power Mgmt power.ti.com Space, Avionics and Defense www.ti.com/space-avionics-defense

Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID www.ti-rfid.com

OMAP Applications Processors www.ti.com/omap TI E2E Community e2e.ti.com

Wireless Connectivity www.ti.com/wirelessconnectivity